

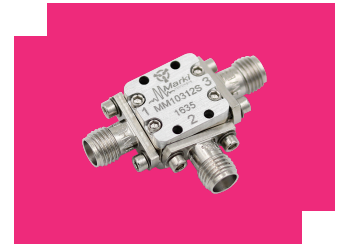
MM1-0312SS

GaAs MMIC Double Balanced Mixer

DEVICE OVERVIEW

General Description

The MM1-0312S is a passive double balanced MMIC mixer. It features excellent conversion loss, superior isolations and spurious performance across a broad bandwidth, in a highly miniaturized form factor. Accurate, nonlinear simulation models are available for Microwave Office® through the Marki Microwave PDK. The MM1-0312S is available as a wire bondable chip or an SMA connectorized package. The MM1-0312S is a superior alternative to Marki Microwave carrier and packaged M1 and M3 mixers.



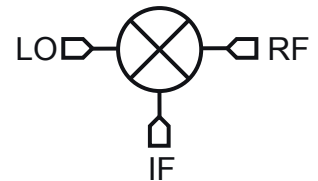
Features

- CAD Optimized for Superior Isolation and Spurious Response
- Broadband Performance
- Excellent Unit-to-Unit Repeatability
- Fully nonlinear software models available with Marki PDK for Microwave Office®
- RoHS Compliant

Applications

- Test and Measurement Equipment
- SATCOM
- Radar

Functional Block Diagram



Part Ordering Options

Part Number	Description	Package	Connectors	Green Status	Product Lifecycle	Export Classification
MM1-0312SS	GaAs MMIC Double Balanced Mixer	S	<u>Standard</u>	REACH RoHS	Released	EAR99

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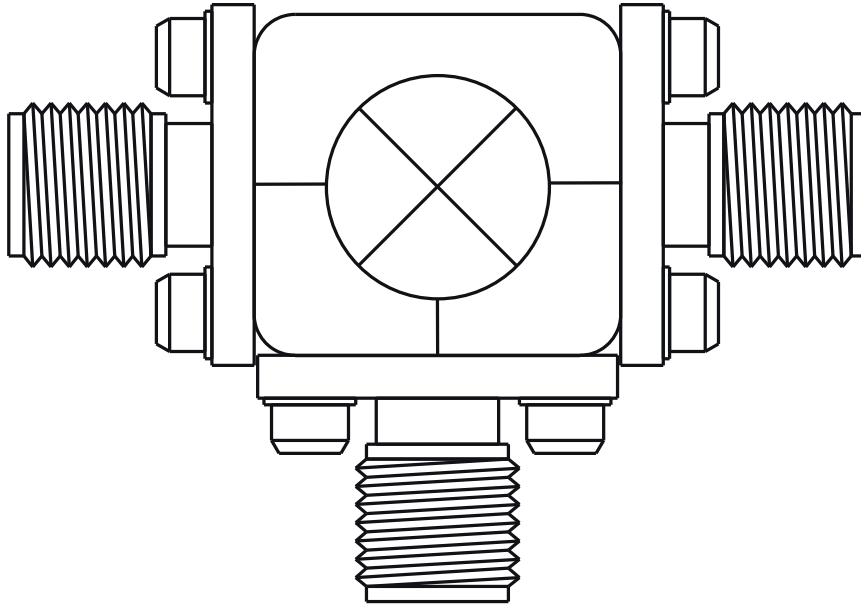
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Revision History

Revision Code	Revision Date	Comment
A	2017-08-01	Die shrunk from 1.48 x 1.18 mm ² to 1.37 x 1.17 mm ² . CH package tolerance added.
B	2020-01-01	Updated CH package Outline Dimensions

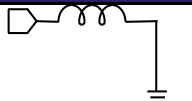
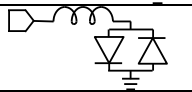
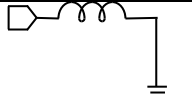
Port Configuration and Functions

Port Diagram

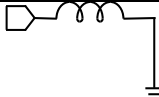
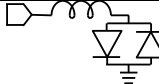
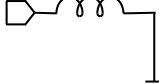


Port Functions

Configuration A

Port	Function	Connector Type	Description	Equivalent Circuit for Package
Port 1	LO	SMAF	Port 1 is DC short and AC matched to 50 Ω from 3 to 12 GHz. Blocking capacitor is optional.	
Port 2	IF	SMAF	Port 2 is DC coupled to the diodes. Blocking capacitor is optional.	
Port 3	RF	SMAF	Port 3 is DC short and AC matched to 50 Ω from 3 to 12 GHz. Blocking capacitor is optional.	

Configuration B

Port	Function	Connector Type	Description	Equivalent Circuit for Package
Port 1	RF	SMAF	Port 1 is DC short and AC matched to 50 Ω from 3 to 12 GHz. Blocking capacitor is optional.	
Port 2	IF	SMAF	Port 2 is DC coupled to the diodes. Blocking capacitor is optional.	
Port 3	LO	SMAF	Port 3 is DC short and AC matched to 50 Ω from 3 to 12 GHz. Blocking capacitor is optional.	

Specifications

Absolute Maximum Ratings

Parameter	Maximum Rating	Unit
Maximum Operating Temperature	100	°C
Maximum Storage Temperature	125	°C
Minimum Operating Temperature	-55	°C
Minimum Storage Temperature	-65	°C
Port 2 DC Current	50	mA
RF Power Handling (RF+LO), 100°C	20	dBm
RF Power Handling (RF+LO), 25°C	25	dBm

Package Information

Parameter	Details	Rating
Dimensions	-	14.22 x 13.21mm

Recommended Operating Conditions

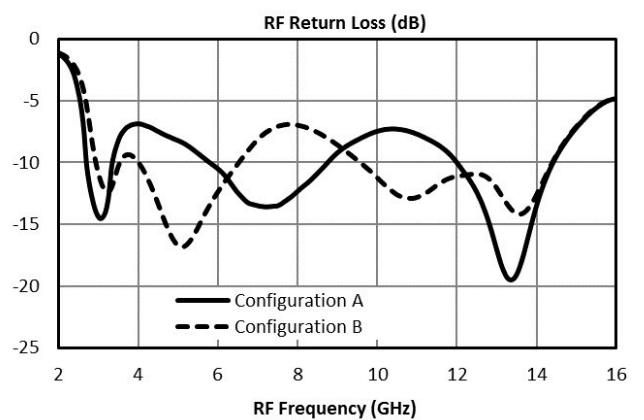
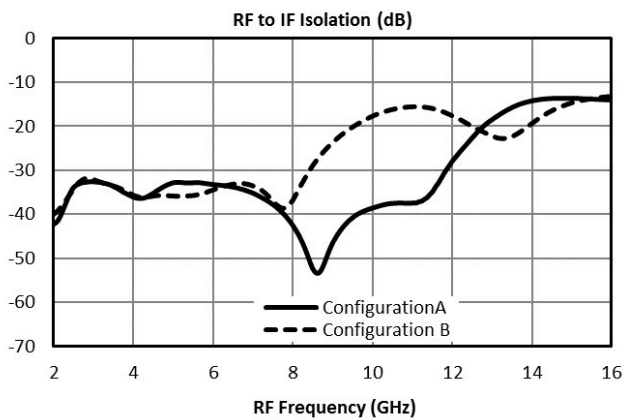
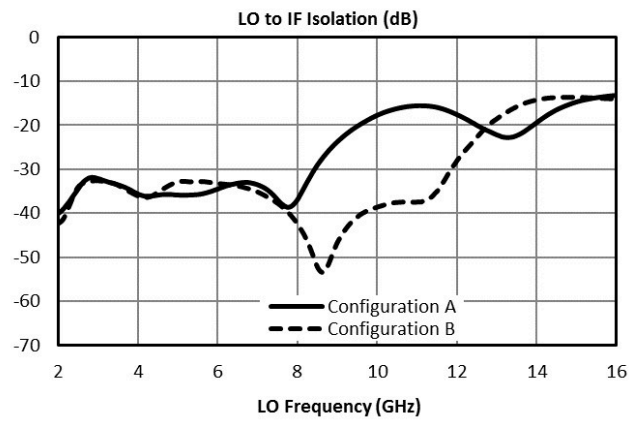
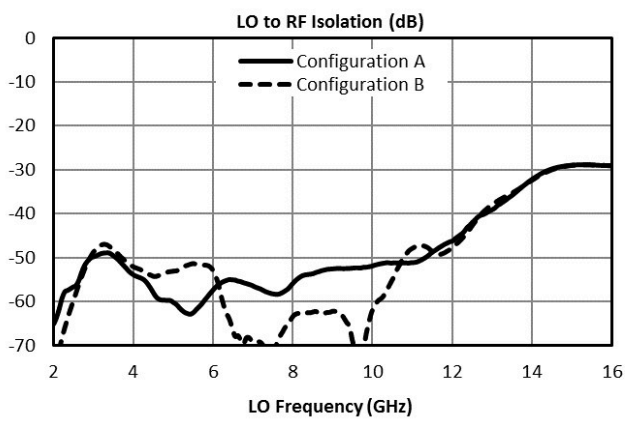
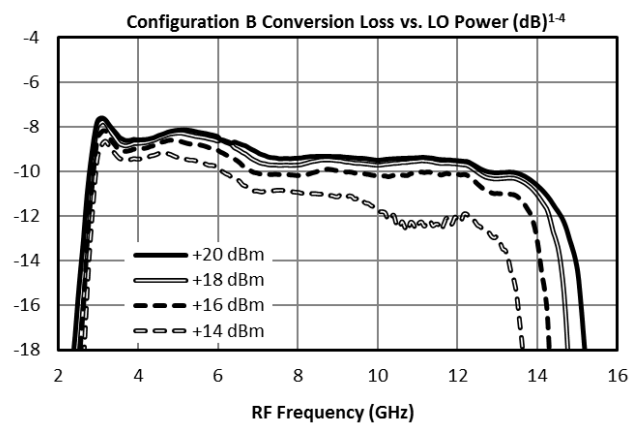
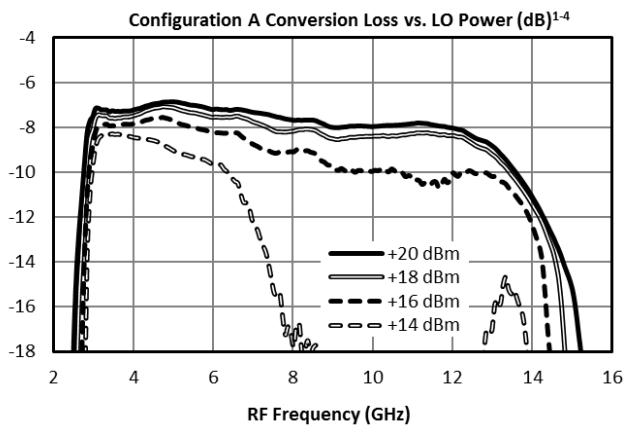
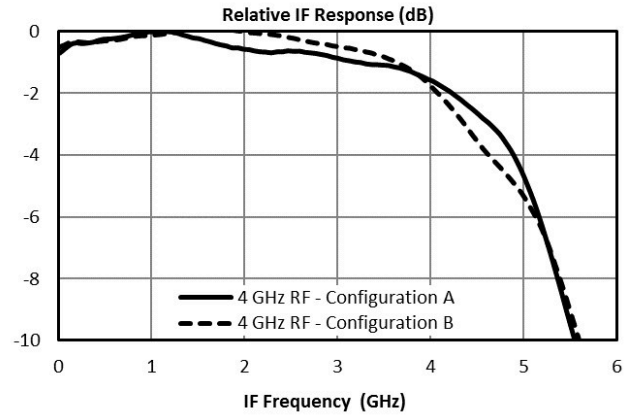
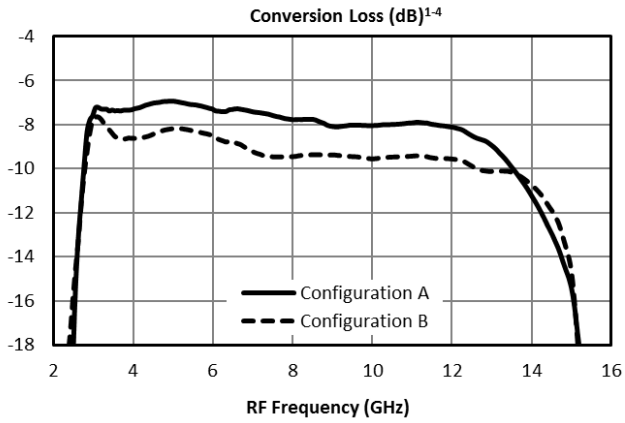
Parameter	Min	Nominal	Max	Unit
LO Input Power	18	-	23	-

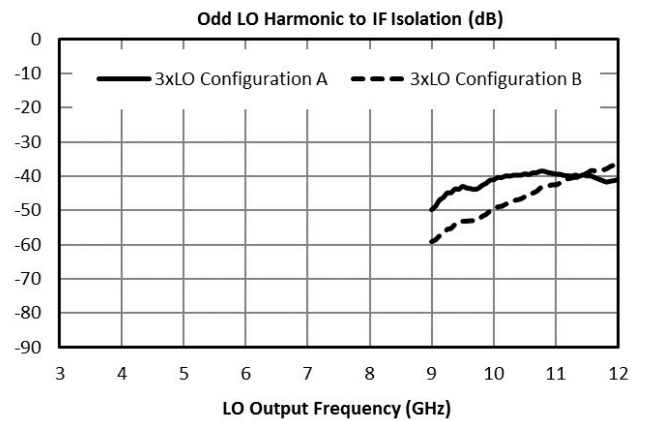
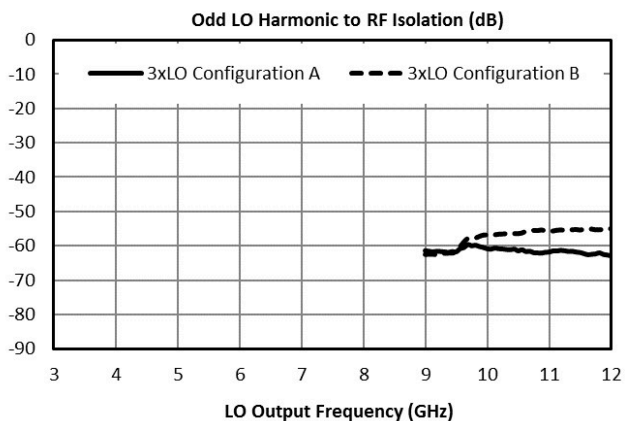
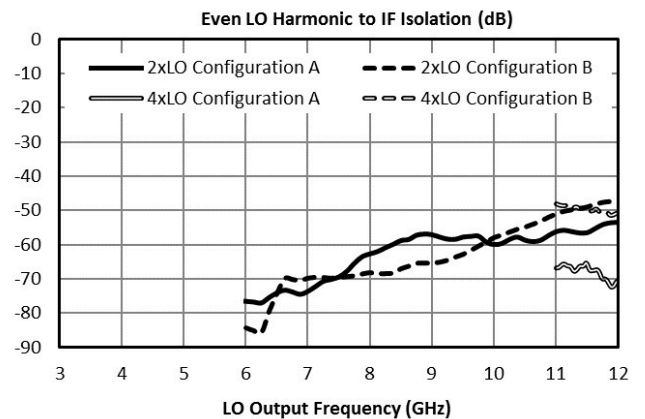
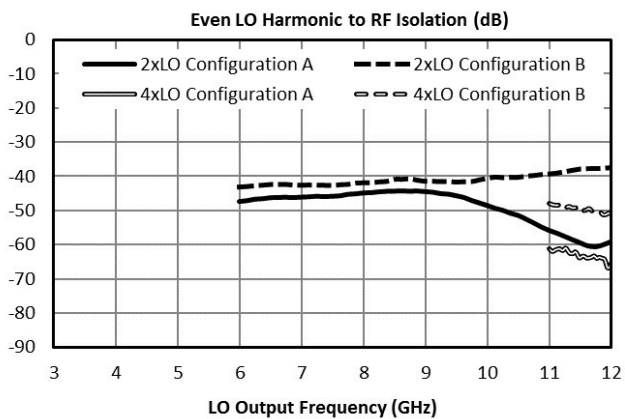
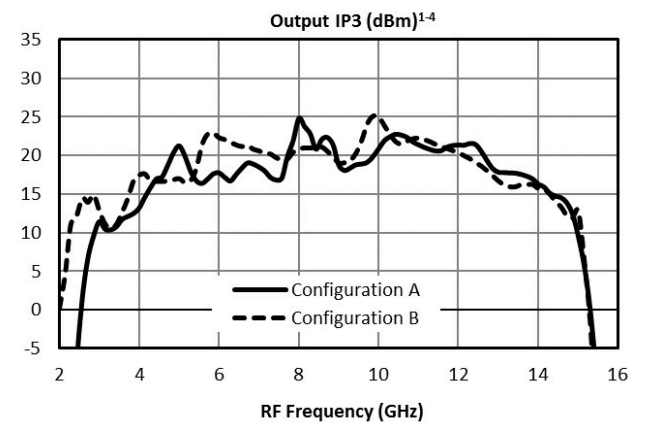
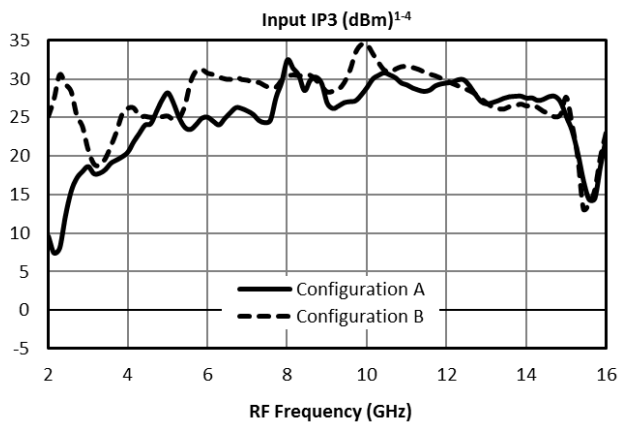
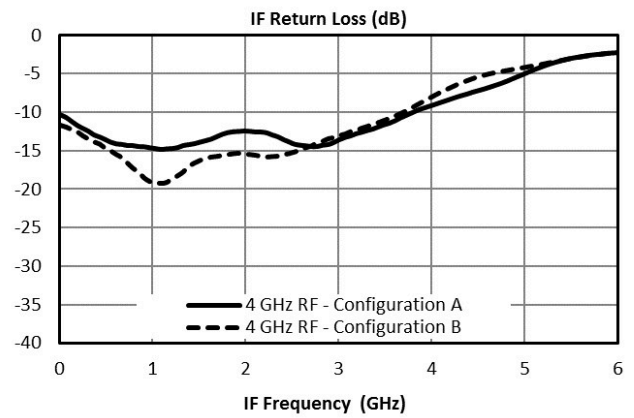
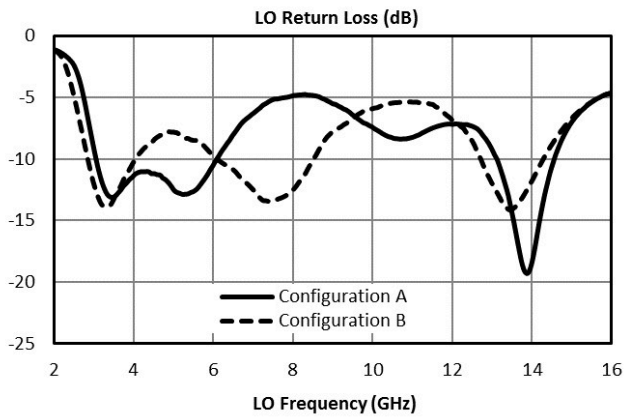
Electrical Specifications

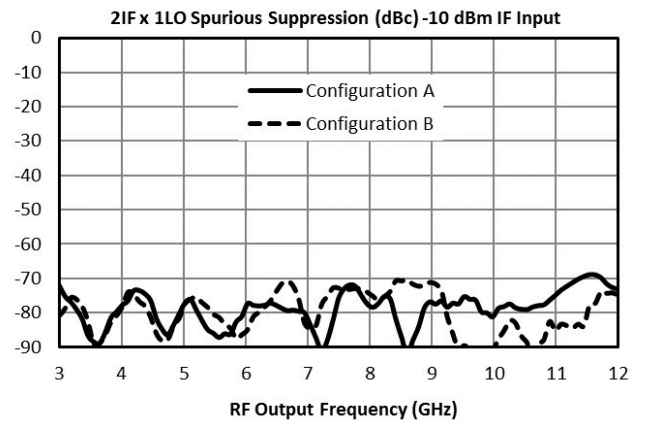
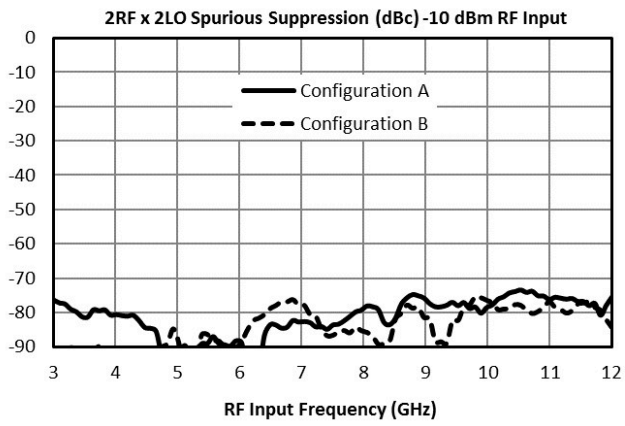
Specifications guaranteed from -55 to +100°C, measured in a 50Ω system. All bare die are 100% DC tested and 100% visually inspected. RF testing is performed on a sample basis to verify conformance to datasheet guaranteed specifications. Consult factory for more information.

Parameter	Port Configuration	Test Conditions	Min	Typ	Max	Unit
Conversion Loss	A	LO/RF=3-12 GHz IF=DC-4.5 GHz LO drive level=20 dBm	-	7.5	-	dB
Input 1 dB Compression	A	LO/RF=3-12 GHz IF=DC-4.5 GHz LO drive level=18-23 dBm	-	14	-	dBm
Input IP3	A	LO/RF=3-12 GHz IF=DC-4.5 GHz LO drive level=18-23 dBm	-	24	-	dBm
Isolation, LO to IF	A	LO/RF=3-12 GHz IF=DC-4.5 GHz LO drive level=18-23 dBm	-	31	-	dB
Isolation, LO to RF	A	LO/RF=3-12 GHz IF=DC-4.5 GHz LO drive level=18-23 dBm	-	47	-	dB
Isolation, RF to IF	A	LO/RF=3-12 GHz IF=DC-4.5 GHz LO drive level=18-23 dBm	-	36	-	dB
Conversion Loss	B	LO/RF=3-12 GHz IF=DC-4.5 GHz LO drive level=20 dBm	-	9	-	dB
Input 1 dB Compression	B	LO/RF=3-12 GHz IF=DC-4.5 GHz LO drive level=18-23 dBm	-	14	-	dBm
Input IP3	B	LO/RF=3-12 GHz IF=DC-4.5 GHz LO drive level=18-23 dBm	-	26	-	dBm
IF Frequency Range	-	-	0	-	4.5	GHz
LO Frequency Range	-	-	3	-	12	GHz
RF Frequency Range	-	-	3	-	12	GHz

Typical Performance







Spur Table

Downconversion Spurious Suppression

Spurious data is taken by selecting RF and LO frequencies (+mLO+nRF) within the 3 to 12 GHz RF/LO bands, which create a 91 MHz IF spurious output. The mixer is swept across the full spurious band and the mean is calculated. The numbers shown in the table below are for a -10 dBm RF input. Spurious suppression is scaled for different RF power levels by (n-1), where “n” is the RF spur order. For example, the 2RFx2LO spur is 82 dBc for the A configuration for a -10 dBm input, so a -20 dBm RF input creates a spur that is (2-1) x (-10 dB) dB lower, or 92 dBc.

Typical Downconversion Spurious Suppression (dBc): A Configuration (B Configuration), Sine Wave LO ⁵

-10 dBm RF Input	0xLO	1xLO	2xLO	3xLO	4xLO	5xLO
1xRF	29 (20)	Reference	33 (47)	17 (15)	35 (45)	N/A
2xRF	72 (75)	67 (60)	82 (85)	76 (64)	82 (91)	75 (74)
3xRF	79 (75)	72 (76)	96 (98)	80 (86)	88 (99)	74 (80)
4xRF	N/A	120 (118)	123 (121)	117 (118)	121 (121)	124 (120)
5xRF	N/A	135 (134)	136 (136)	131 (132)	135 (136)	128 (128)

Specifications are subject to change without notice. Contact Marki Microwave for the most recent specifications and data sheets.

Upconversion Spurious Suppression

Spurious data is taken by mixing a 91 MHz IF with LO frequencies (+mLO+nIF), which creates an RF within the 3 to 12 GHz RF band. The mixer is swept across the full spurious output band and the mean is calculated. The numbers shown in the table below are for a -10 dBm IF input. Spurious suppression is scaled for different IF input power levels by (n-1), where “n” is the IF spur order. For example, the 2IFx1LO spur is typically 79 dBc for the A configuration for a -10 dBm input, so a -20 dBm IF input creates a spur that is (2-1) x (-10 dB) dB lower, or 89 dBc.

Typical Upconversion Spurious Suppression (dBc): A Configuration (B Configuration), Sine Wave LO ⁵

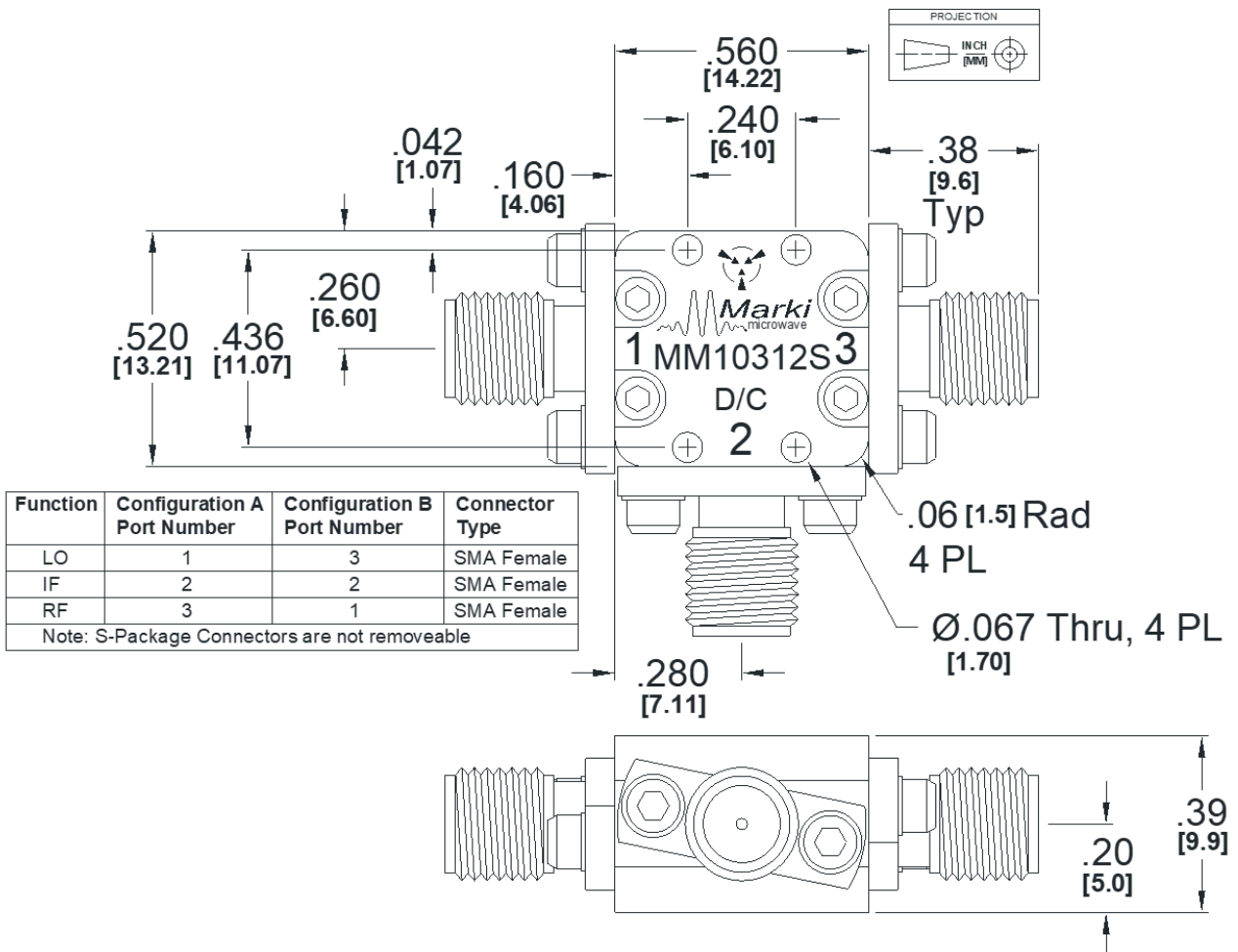
-10 dBm RF Input	0xLO	1xLO	2xLO	3xLO	4xLO	5xLO
1xIF	26 (26)	Reference	36 (42)	13 (12)	35 (46)	21 (23)
2xIF	68 (61)	79 (80)	73 (63)	76 (81)	76 (67)	79 (85)
3xIF	86 (93)	80 (81)	89 (98)	79 (79)	89 (97)	78 (81)
4xIF	114 (102)	122 (123)	119 (114)	127 (126)	125 (115)	124 (124)
5xIF	120 (134)	131 (133)	137 (136)	132 (136)	137 (136)	132 (130)

Specifications are subject to change without notice. Contact Marki Microwave for the most recent specifications and data sheets.

Mechanical Data

Outline Drawing

Download : [Outline 2D Drawing](#) | [Outline 3D Drawing](#) | [Outline 3D STP](#)



Notes

1. Mixer Conversion Loss Plot IF frequency is 100 MHz.
2. Mixer Noise Figure typically measures within 0.5 dB of conversion loss for IF frequencies greater than 5 MHz.
3. Conversion Loss typically degrades less than 0.5 dB at +100°C and improves less than 0.5 dB at -55°C.
4. Unless otherwise specified, data is taken with +20 dBm lowside LO drive.
5. Specifications are subject to change without notice. Contact Marki Microwave for the most recent specifications and data sheets.
6. Catalog mixer circuits are continually improved. Configuration control requires custom mixer model numbers and specifications.

Note: Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

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